

Overview

HP EliteBook 1040 14" G9 Notebook PC



Left

1. Internal Microphones (2)
2. Ambient Light Sensor (Optional)
3. Webcam
4. Camera Shutter
5. IR Camera (Optional)
6. IR Camera LEDs (Optional)
7. Glass Clickpad
8. Smartcard Reader (Optional)
9. LED Indicator
10. Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)¹
11. Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4)¹
12. SuperSpeed USB Type-A 5Gbps signaling rate (USB 3.2 Gen 1)
13. HDMI 2.0b Port (Cable not included)

1. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

Overview



Right

- | | |
|--|---|
| 1. Power Button Key | 4. Nano Security Lock Slot (Lock sold separately) |
| 2. Audio Combo Jack | 5. SIM Card Slot (Optional) |
| 3. SuperSpeed USB Type-A 5Gbps signaling rate (Charging) (USB 3.2 Gen 1) | 6. Touch Fingerprint Sensor (Select models) |

Overview

At a Glance

- Preinstalled with Windows 11 versions or FreeDOS
- A new clamshell ultraslim design with precision-crafted magnesium chassis for a premium look and feel
- 12th Generation Intel® Core™ i5, i7 U series, up to ten-core
- New 16:10 aspect ratio screen reduces the need to scroll by showing more vertical content than 16:9
- New 5MP camera with HP Auto Frame allows you around a little without losing viewers' attention during video calls
- New DDR5 memory (up to 64GB) and PCI Gen4 SSDs provide fast access to your work.
- Choice of displays:
 - 35.6 cm (14") diagonal AG WUXGA (1920x1200) LED-backlit, 250 nits, 45% NTSC, non-touch
 - 35.6 cm (14") diagonal AG WUXGA (1920x1200) LED-backlit, 250 nits, 45% NTSC, touchscreen
 - 35.6 cm (14") diagonal AG WUXGA (1920x1200) LED-backlit, 400 nits, 100% sRGB, non-touch with HP Eye Ease
 - 35.6 cm (14") diagonal AG WUXGA (1920x1200) LED-backlit, 1000 nits, 100% sRGB, HP Sure View Reflect, non-touch with HP Eye Ease
- Redesigned keyboard layout to include easy use of discrete PgUp/Dn, End, and Home keys
- Choose from 38Wh or 51Wh battery options
- HP Wolf Security for Business creates a hardware-enforced, always-on, resilient defense
- Larger clickpad surface for easier, more intuitive input
- Connectivity with optional Intel® 5000 5G/WWAN available world-wide, and Thunderbolt™ Docking (Dock sold separately)
- Undergoes MIL-STD 810H tests
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support all HP docking options including the HP Universal Dock G5

NOTE: See important legal disclosures for all listed specs in their respective features sections.

Technical Specifications

PRODUCT NAME

HP EliteBook 1040 14" G9 Notebook PC

OPERATING SYSTEMS

Preinstalled

Windows 11 Pro ¹
 Windows 11 Pro Education ¹
 Windows 11 Home – HP recommends Windows 11 Pro for Business¹
 Windows 11 Home Single Language – HP recommends Windows 11 Pro for Business¹
 Windows 10 Pro (available through downgrade rights from Windows 11 Pro) ¹
 Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) ^{1,2}
 FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <http://www.windows.com>.

2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

Processor 3,4,5,6,7	Cores	Number of P-cores	Number of E-cores	Threads	L3 Cache	Max Turbo Frequency		Base Frequency		Intel SIPP/vPro® Enterprise
						P-cores	E-cores	P-cores	E-cores	
Intel® Core™ i7-1265U	10	2	8	12	12MB	4.8 GHz	3.6 GHz	1.8 GHz	1.3 GHz	X
Intel® Core™ i7-1255U	10	2	8	12	12MB	4.7 GHz	3.5 GHz	1.7 GHz	1.2 GHz	
Intel® Core™ i5-1245U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.2 GHz	1.2 GHz	X
Intel® Core™ i5-1235U	10	2	8	12	12MB	4.4 GHz	3.3 GHz	1.3 GHz	0.9 GHz	

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See www.intel.com/technology/turboboost for more information.

Technical Specifications

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on <http://www.support.hp.com>.

7. Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See <http://intel.com/vpro>

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® Xe Graphics ⁸

Supports

Support HD decode, DX12, HDMI 2.0b, HDCP 2.3 ⁹

8. Intel® Iris® Xe Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xe Graphics with Intel® Core™ i5 or 7 processors and single channel memory will only function as UHD graphics.

9. HDMI cable sold separately

DISPLAY

Non-Touch

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, time of flight sensor, with 5 MP+IR camera (1920 x 1200) ^{10,11}

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, time of flight sensor, with 5 MP+IR camera for WWAN (1920 x 1200) ^{10,11}

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera (1920 x 1200) with HP Eye Ease ^{10,11}

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 400 nits, 100% sRGB, Low Power, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR Camera for WWAN (1920 x 1200) with HP Eye Ease ^{10,11}

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera (1920 x 1200) with HP Eye Ease ^{10,11,12,13}

35.56 cm (14") diagonal WUXGA Bent, Low Blue Light, anti-glare UWVA eDP+PSR, 1000 nits, 100% sRGB with HP Sure View Reflect integrated privacy screen, Ambient Light Sensor+Ambient Color Sensor, time of flight sensor, with 5MP+IR camera for WWAN (1920 x 1200) with HP Eye Ease ^{10,11,12,13}

Touch

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, with 5 MP+IR camera, time of flight sensor Touch on Panel (1920 x 1200) ^{10,11,13}

Technical Specifications

35.6 cm (14") diagonal, WUXGA bent, anti-glare UWVA, 250 nits, 45%NTSC, with 5 MP+IR camera, time of flight sensor for WWAN Touch on Panel (1920 x 1200) ^{9,10,12}

DisplayPort™ 1.2

HDMI 2.0 Support resolution up to 4K @60 Hz ⁹

Displays support

Supports dual display through the dock

Display Size (diagonal)

14"

35.56 cm (14")

9. HDMI cable sold separately

10. HD content required to view HD images.

11. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

12. HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

13. Actual brightness will be lower with touchscreen or HP Sure View.

DOCKING (Sold Separately)

Docking station model #1

HP Thunderbolt Dock G2

Docking station model #2

HP USB-C Dock G5

Docking station model #3

HP USB-C/A Universal Dock G2

For additional aftermarket options and docking specs please see page 41.

STORAGE AND DRIVES

Primary M.2 Storage

2 TB PCIe® Gen4x4 NVMe™ M.2 SSD TLC ¹⁴

1 TB PCIe® Gen4x4 NVMe™ M.2 SSD TLC ¹⁴

512 GB PCIe® Gen4x4 NVMe™ M.2 SSD TLC ¹⁴

512 GB PCIe® Gen4x4 NVMe™ SED TLC OPAL2 ¹⁴

512 GB PCIe® NVMe™ Value M.2 SSD ¹⁴

256 GB PCIe® Gen4x4 NVMe™ M.2 SSD TLC ¹⁴

256 GB PCIe® Gen4x4 NVMe™ SED TLC OPAL2 ¹⁴

256 GB PCIe® NVMe™ Value M.2 SSD ¹⁴

14. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

Technical Specifications

MEMORY

Maximum Memory

64GB DDR5-4800 ¹⁵

Memory

64GB DDR5-4800 (2x32GB) ¹⁵

32GB DDR5-4800 (2x16GB) ¹⁵

32GB DDR5-4800 (1x32GB) ¹⁵

16GB DDR5-4800 (2x8GB) ¹⁵

16GB DDR5-4800 (1x16GB) ¹⁵

8GB DDR5-4800 (1x8GB) ¹⁵

Memory Slots

2 SODIMM

DDR5 SODIMMS, system runs at 4800

Supports Dual Channel Memory

15. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Intel® AX211 Wi-Fi6E + Bluetooth® 5.3 M.2 160MHz CNVi Word-Wide WLAN vPro ^{16,17,18}

Intel® AX211 Wi-Fi6E + Bluetooth® 5.3 M.2 160MHz CNVi Word-Wide WLAN non-vPro ^{16,18}

WWAN

Intel® 5000 5G Solution WWAN ^{19,20}

Intel® XMM 7560 R+ LTE-Advanced Pro WWAN (Cat 16) ¹⁹

NFC

Near Field Communications Controller ²¹

HP Module with NXP NFC Controller NPC300 I2C NCI

Miracast

Native Miracast Support ²²

16. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

17. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

18. For full Intel® vPro™ functionality, Windows, a vPro supported processor, vPro enabled chipset, vPro enabled WLAN card and discrete TPM 2.0 are required. See <https://www.intel.com/content/www/us/en/architecture-and-technology/vpro/vpro-platform-general.html>

19. WWAN module is an optional feature, requires factory configuration and requires separately purchased service contract. Check with service provider for coverage and availability in your area. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products, in all regions.

20. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz

Technical Specifications

of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

21. Sold separately or as an optional feature.

22. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio by Bang & Olufsen

2 Integrated stereo speakers

Discrete Amplifiers

Integrated dual array microphone

Speaker Power

2W/4ohm Per speaker

Camera

5 MP+IR camera ²¹

Sensors

ALS (ambient light sensor)

Magnetometer

Hall Sensor

Gyro

Accelerometer

HP Tamper Lock ²³

21. Sold separately or as an optional feature.

23. HP Tamper Lock must be enabled by the customer or your administrator.

Technical Specifications

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant, Backlit keyboard and DuraKeys

Pointing Device

Clickpad with multi-touch gesture support, taps enabled as default

Microsoft Precision Touchpad Default Gestures Support

Function Keys

ESC: system information

F1 - Display Switching

F2 - Blank or Privacy

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Insert

F11 - Airplane Mode

F12 - HP Command Center

home

end

Power Button (with LED)

Delete

Hidden Function Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

Technical Specifications

SOFTWARE AND SECURITY

Software

HP Quick Touch
HP Quick Drop ²⁴
HP Easy Clean²⁵
HP PC Hardware Diagnostics Windows
myHP
HP Smart Support ²⁶
HP Connection Optimizer
HP Hotkey Support
HP Support Assistant ²⁷
HP Notifications
HP Privacy Settings
HP Power Manager
Buy Microsoft Office (Sold separately)

Manageability Features

HP Image Assistant Gen5 (download)
HP Manageability Integration Kit (download) ²⁸
HP Client Management Script Library (download)
HP Driver Packs (download)
HP Cloud Recovery ²⁹
HP Client Catalog (download)

Security Management

HP Wolf Security of Business ³⁰ includes:

HP Sure Click ³¹
HP Sure Sense ³²
HP Sure Run Gen5 ³³
HP Sure Recover Gen5 ³⁴
HP Sure Start Gen7 ³⁵
HP Tamper Lock
HP Sure Admin ³⁶
HP Client Security Manager Gen7 ³⁷

BIOS

HP BIOSphere Gen6 ³⁸
HP Secure Erase ³⁹
Absolute Persistence Module ⁴⁰
HP DriveLock & Automatic DriveLock
BIOS Update via Network
HP Wake on WLAN
HP Fingerprint Sensor ⁴¹
Secured-Core PC Enable ⁴²
TPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified)

Security

TPM

Model: Infineon SLB9672VU2.0

Technical Specifications

Version: 15.21

Revision: TPM 2.0

FIPS 140-2 Compliant: Yes

Smartcard Reader

Model number: Alcor AU9560

FIPS 201 Compliant: Yes

IPv6 Support

Yes

FirstNet Certified

Yes

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7

Class: Class 3

24. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

25. HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.

26. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit <http://www.hp.com/smart-support>.

27. HP Support Assistance requires Windows and Internet Access.

28. HP Manageability Integration Kit can be downloaded from <http://www8.hp.com/us/en/ads/clientmanagement/overview.html>.

29. HP Cloud Recovery is available for Z by HP, HP Elite and Pro desktops and laptops PCs with Intel® or AMD processors and requires an open, wired network connection. **NOTE:** You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Detail please refer to: <https://support.hp.com/us-en/document/c05115630>.

30. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement..

31. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

32. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

33. HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

34. HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module.

35. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher.

36. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from <http://www.hp.com/go/clientmanagement> and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

37. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs.

38. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

Technical Specifications

- 39. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
 - 40. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: <https://www.absolute.com/about/legal/agreements/absolute/>.
 - 41. HP Fingerprint sensor is an optional feature that must be configured at purchase.
 - 42. Secured-Core PC Enable requires an Intel® vPro®, AMD Ryzen™ Pro processor or Qualcomm® processor with SD850 or higher and requires 8 GB or more system memory. Secured-core PC is enabled from the factory.
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Technical Specifications

POWER

Power Supply

HP Smart 65 W USB Type-C adapter ⁴³

HP Smart 65 W Slim USB Type-C adapter ⁴³

HP Smart 45 W USB Type-C adapter ⁴³

Battery

HP Long Life 3-cell, 38 Wh Polymer ^{44,45}

HP Long Life 3-cell, 51 Wh Polymer ^{44,45}

Compliant with UL 1642 Standard

Power Cord

3-wire plug - 1m

2-wire plug - 1m

Battery Life

Up to 13 hours 45 minutes (51 Whr battery) ⁴⁶

Up to 10 hours (38 Whr battery) ⁴⁶

43. Availability may vary by country.

44. Battery is internal and not replaceable by customer. Serviceable by warranty.

45. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

46. MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <http://www.bapco.com> for additional details.

WEIGHTS & DIMENSIONS

Product Weight- 38 Whr ⁴⁷

Starting at 2.56 lb

Starting at 1.16 kg

Product Dimensions (W x D x H)

12.41 x 8.83 x 0.76 in

31.52 x 22.431 x 1.931 cm

47. Weight will vary by configuration. Does not include power adapter.

Technical Specifications

PORTS/SLOTS

- 2 Thunderbolt™ 4 with USB4 Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 1.4) ⁴⁸
- 2 Super Speed USB Type-A 5Gbps signaling rate (1 charging) (USB 3.2 Gen 1)
- 1 HDMI 2.0 ⁹
- 1 Headphone/microphone combo jack
- 1 Nano Security Lock Slot (Lock sold separately)
- 1 Smartcard reader (Optional)
- 1 nano SIM card slot

9. HDMI cable sold separately

48. SuperSpeed USB 20Gbps is not available with Thunderbolt™ 4.

Technical Specifications

SERVICE AND SUPPORT

1-year warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for HP Long Life batteries which will follow the one or three year warranty of the platform. Refer to <http://www.hp.com/support/batterywarranty/> for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>.⁴⁹

49. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

Technical Specifications

SYSTEM UNIT**Stand-Alone Power Requirements (AC Power)** Type-C Adapter

Nominal Operating Voltage AC 20V

Average Operating Power

Integrated graphics Yes

Discrete Graphics N/A

Max Operating Power UMA<65W

Temperature

Operating 32° to 95° F (0° to 35° C)

Non-operating 41° to 95° F (5° to 35° C) (writing optical)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine

Non-operating 200 G, 2 ms, half-sine

Random Vibration

Operating 0.75 grams

Non-operating 1.50 grams

Altitude (unpressurized)

Operating -50 to 10,000 ft (-15.24 to 3,048 m)

Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry Standard**Certifications**

Regulatory Model Number HSN-I45C-4

UL Yes

CSA Yes

FCC Compliance Yes

ENERGY STAR® Certified ⁵⁰EPEAT® EPEAT® Gold in the United States ⁵¹

ICES Yes

Australia / Yes

NZ A-Tick Compliance Yes

CCC Yes

Japan VCCI Compliance Yes

KC Yes

BSMI Yes

CE Marking Compliance Yes

BNCI or BELUS Yes

CIT Yes

GOST Yes

Saudi Arabian Compliance (ICCP) Yes

SABS Yes

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50. Configurations of the HP EliteBook 1040 14" G9 Notebook PC that are ENERGY STAR® qualified are identified as HP EliteBook 1040 14" G9 Notebook PC ENERGY STAR on HP websites and on <http://www.energystar.gov>.

51. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit <http://www.epeat.net> for more information.

DISPLAYS

NOTE: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 eDP 1.2 w/o PSR 45 bent LCD Panel	Outline Dimensions (W x H x D)	307.590 x 199.550 (max)
	Active Area	301.590 X 188.500 (typ)
	Weight	300 (max)
	Diagonal Size	14
	Thickness	3.0 / 5.0 (max)
	Interface	eDP 1.2
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	1000:1 (typ)
	Refresh Rate	60 Hz
	Brightness	250 nits
	Pixel Resolution - Format	1920 x 1200 (WUXGA)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	8 bits
	Viewing Angle	UWVA 89/89/89/89
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.20 (max) / 2.70 (max)

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA LED NTSC NB2X 250 TOP eDP 1.2 w/o PSR 45 bent LCD Panel	Outline Dimensions (W x H x D)	307.590 x 199.550 (max)
	Active Area	301.590 x 188.500 (typ)
	Weight	300 (max)
	Diagonal Size	14
	Thickness	3.0 / 5.0 (max)
	Interface	eDP 1.2
	Surface Treatment	Anti-Glare
	Touch Enabled	Yes ¹
	Contrast Ratio	1000:1 (typ)
	Refresh Rate	60 Hz
	Brightness	250 nits ¹
	Pixel Resolution - Format	1920 x 1200 (WUXGA)
	Backlight	WLED
	Pixel Resolution	RGB

Technical Specifications

	Color Gamut Coverage	NTSC 45%
	Color Depth	8 bits
	Viewing Angle	UWVA 89/89/89/89
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.10 (max) / 2.60 (max)

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2X 400 eDP 1.4+PSR2 Low-Power 100 bent LCD Panel	Outline Dimensions (W x H x D)	307.590 x 199.550 (max)
	Active Area	301.590 X 188.500 (typ)
	Weight	210 (max)
	Diagonal Size	14
	Thickness	2.0 / 3.8 (max)
	Interface	eDP 1.4
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	1000:1 (typ)
	Refresh Rate	60 Hz
	Brightness	400 nits
	Pixel Resolution - Format	1920 x 1200 (WUXGA)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	sRGB 100%
	Color Depth	8 bits
	Viewing Angle	UWVA 89/89/89/89
	Low Blue Light	Yes
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	1.29 (max) / 1.66 (max)

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA WLED+LBL sRGB NB2Y 1000 eDP 1.3+PSR 100 PrivacyG4 Plus bent LCD Panel	Outline Dimensions (W x H x D)	307.600 x 199.550 (typ)
	Active Area	301.680 x 188.500 (typ)
	Weight	238 (max)
	Diagonal Size	14
	Thickness	2.2 / 3.9 (max)
	Interface	eDP 1.3
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	1500:1 (typ)
	Refresh Rate	60 Hz
	Brightness	1000 nits
	Pixel Resolution - Format	1920 x 1200 (WUXGA)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	sRGB 100%
	Color Depth	8 bits

Technical Specifications

Viewing Angle	UWVA 85/85/85/85
Low Blue Light	Yes
Power Consumption (W, EBL@ 150nits max/ 200nits max)	N/A

Technical Specifications

STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10 and 11) is reserved for system recovery software.

SSD 256GB 2280 PCIe-4x4 NVMe Three Layer Cell	Form Factor	M.2 2280
	Capacity	256GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	4000 MB/s ±20%
	Maximum Sequential Write	2000 MB/s ±20%
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell	Form Factor	M.2 2280
	Capacity	512GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s ±20%
	Maximum Sequential Write	3500 MB/s ±20%
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell	Form Factor	M.2 2280
	Capacity	1TB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s ±20%
	Maximum Sequential Write	5000 MB/s ±20%
	Logical Blocks	2,000,409,264
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2

Technical Specifications

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell	Form Factor	M.2 2280
	Capacity	2TB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s $\pm 20\%$
	Maximum Sequential Write	5000 MB/s $\pm 20\%$
	Logical Blocks	4,000,797,360
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2

256GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive	Form Factor	M.2 2280
	Capacity	256GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	4000 MB/s $\pm 20\%$
	Maximum Sequential Write	2000 MB/s $\pm 20\%$
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TCG Opal 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive	Form Factor	M.2 2280
	Capacity	512GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen4X4
	Maximum Sequential Read	6400 MB/s $\pm 20\%$
	Maximum Sequential Write	3500 MB/s $\pm 20\%$
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	TCG Opal 2.0; TRIM; L1.2

Technical Specifications

SSD 256GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	1500 MB/s ±20%
	Maximum Sequential Write	750 MB/s ±20%
	Logical Blocks	500,118,192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2

SSD 512GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
	Capacity	512 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.02 lb (10 g)
	Interface	PCIe NVMe Gen3X4
	Maximum Sequential Read	1500 MB/s ±20%
	Maximum Sequential Write	750 MB/s ±20%
	Logical Blocks	1,000,215,215
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite 2.0; TRIM; L1.2

Technical Specifications

NETWORKING/COMMUNICATIONS

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 M.2 160MHz CNVi World-Wide WLAN vPro®^{1,5}	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability Frequency Band	Wi-Fi certified •802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz 6.535 – 6.875 GHz 6.895 – 7.115 GHz
	Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: max 300Mbps • 802.11ac : 1733Mbps • 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security²	• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • WPA3 certification • IEEE 802.11i • WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power³	• 802.11b : +17dBm minimum • 802.11g : +16dBm minimum • 802.11a : +17dBm minimum • 802.11n HT20(2.4GHz) : +14dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum

Technical Specifications

- 802.11n HT20(5GHz) : +14dBm minimum
- 802.11n HT40(5GHz) : +13dBm minimum
- 802.11ac VHT80(5GHz) : +10dBm minimum
- 802.11ac VHT160(5GHz) : +10dBm minimum
- 802.11ax HE40(2.4GHz) : +12dBm minimum
- 802.11ax HE80(5GHz) : +10dBm minimum
- 802.11ax HE160(5GHz) : +10dBm minimum

Power Consumption

- Transmit mode 2.0 W
- Receive mode 1.6 W
- Idle mode (PSP) 180 mW (WLAN Associated)
- Idle mode 50 mW (WLAN unassociated)
- Connected Standby 10mW
- Radio disabled 8 mW

Power Management

ACPI and PCI Express compliant power management
802.11 compliant power saving mode

Receiver Sensitivity⁴

- 802.11b, 1Mbps : -93.5dBm maximum
- 802.11b, 11Mbps : -84dBm maximum
- 802.11a/g, 6Mbps : -86dBm maximum
- 802.11a/g, 54Mbps : -72dBm maximum
- 802.11n, MCS07 : -67dBm maximum
- 802.11n, MCS15 : -64dBm maximum
- 802.11ac, MCS0(VHT80) : -84dBm maximum
- 802.11ac, MCS9(VHT80) : -59dBm maximum
- 802.11ac, MCS9(VHT160) : -58.5dBm maximum
- 802.11ax, MCS11(HE40): -57dBm maximum
- 802.11ax, MCS11(HE80): -54dBm maximum
- 802.11ax, MCS11(HE160): -53.5dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display enclosure
Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor

PCI-Express M.2 MiniCard

Dimensions

1. Type 2230: 2.3 x 22.0 x 30.0 mm

Weight

1. Type 2230: 2.8g

Operating Voltage

3.3v +/- 9%

Temperature

Operating 14° to 158° F (–10° to 70° C)
Non-operating –40° to 176° F (–40° to 80° C)

Humidity

Operating 10% to 90% (non-condensing)
Non-operating 5% to 95% (non-condensing)

Altitude

Operating 0 to 10,000 ft (3,048 m)
Non-operating 0 to 50,000 ft (15,240 m)

LED Activity

LED Amber – Radio OFF; LED OFF – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Technology**Bluetooth Specification**

4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant

Frequency Band

2402 to 2480 MHz

Number of Available Channels

Legacy : 0~79 (1 MHz/CH)
BLE : 0~39 (2 MHz/CH)

Data Rates and Throughput

Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
BLE : 1 Mbps data rate; throughput up to 0.2 Mbps
Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Technical Specifications

	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management Certifications	ETS 300 328, ETS 300 826
	Low Voltage Directive IEC950
Bluetooth Profiles Supported	UL, CSA, and CE Mark BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
2. Check latest software/driver release for updates on supported security features.
3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Technical Specifications

Intel® AX211 Wi-Fi 6E + Bluetooth® 5.3 M.2 160MHz CNVi World-Wide WLAN non-vPro®^{1,5}	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v
	Interoperability	Wi-Fi certified
	Frequency Band	• 802.11b/g/n/ax 2.402 – 2.482 GHz • 802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.955 – 6.415 GHz 6.435 – 6.515 GHz 6.535 – 6.875 GHz 6.895 – 7.115 GHz
	Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: max 300Mbps • 802.11ac : 1733Mbps • 802.11ax : max 2.4Gbps
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security²	• IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only • AES-CCMP: 128 bit in hardware • 802.1x authentication • WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. • WPA2 certification • WPA3 certification • IEEE 802.11i • WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power³	• 802.11b : +17dBm minimum • 802.11g : +16dBm minimum • 802.11a : +17dBm minimum • 802.11n HT20(2.4GHz) : +14dBm minimum • 802.11n HT40(2.4GHz) : +13dBm minimum • 802.11n HT20(5GHz) : +14dBm minimum • 802.11n HT40(5GHz) : +13dBm minimum

Technical Specifications

	<ul style="list-style-type: none"> • 802.11ac VHT80(5GHz) : +10dBm minimum • 802.11ac VHT160(5GHz) : +10dBm minimum • 802.11ax HE40(2.4GHz) : +12dBm minimum • 802.11ax HE80(5GHz) : +10dBm minimum • 802.11ax HE160(5GHz) : +10dBm minimum
Power Consumption	<ul style="list-style-type: none"> • Transmit mode 2.0 W • Receive mode 1.6 W • Idle mode (PSP) 180 mW (WLAN Associated) • Idle mode 50 mW (WLAN unassociated) • Connected Standby 10mW • Radio disabled 8 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity⁴	<ul style="list-style-type: none"> • 802.11b, 1Mbps : -93.5dBm maximum • 802.11b, 11Mbps : -84dBm maximum • 802.11a/g, 6Mbps : -86dBm maximum • 802.11a/g, 54Mbps : -72dBm maximum • 802.11n, MCS07 : -67dBm maximum • 802.11n, MCS15 : -64dBm maximum • 802.11ac, MCS0(VHT80) : -84dBm maximum • 802.11ac, MCS9(VHT80) : -59dBm maximum • 802.11ac, MCS9(VHT160) : -58.5dBm maximum • 802.11ax, MCS11(HE40) : -57dBm maximum • 802.11ax, MCS11(HE80) : -54dBm maximum • 802.11ax, MCS11(HE160) : -53.5dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications
Form Factor	PCI-Express M.2 MiniCard
Dimensions	1. Type 2230 : 2.3 x 22.0 x 30.0 mm 2. Type 1216: 1.67 x 12.0 x 16.0 mm
Weight	1. Type 2230 : 2.8g 2. Type 1216: 1.3g
Operating Voltage	3.3v +/- 9%
Temperature	Operating 14° to 158° F (-10° to 70° C) Non-operating -40° to 176° F (-40° to 80° C)
Humidity	Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)
Altitude	Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED OFF – Radio ON
HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3 Wireless Technology	
Bluetooth Specification	4.0/4.1/4.2/5.0/5.1/5.2/5.3 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy: 0~79 (1 MHz/CH) BLE: 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

Technical Specifications

Transmit Power	asymmetric (3-DH5) or 864 kbps symmetric (3-EV5) The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 9.5 dBm for BR and EDR.
Power Consumption	Peak (Tx): 330 mW Peak (Rx): 230 mW Selective Suspend: 17 mW
Bluetooth Software Supported	Microsoft Windows Bluetooth Software
Link Topology	
Power Management	Microsoft Windows ACPI, and USB Bus Support
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249
Power Management	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950
Certifications	UL, CSA, and CE Mark
Bluetooth Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy LE Privacy 1.2 –Extended Scanner Filter Policies LE Data Packet Length Extension FAX Profile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP) BT5.2 ESR9/10 Compliance LE Advertisement Extensions Channel Selection Algo Limited High Duty Cycle Non-Connectable Advertising 2Mbps LE LE Long Range

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.
2. Check latest software/driver release for updates on supported security features.
3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).
5. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

Technical Specifications

**Intel(R) 5G Solution
5000¹****Technology/Operating
bands**

WCDMA/HSPA+ operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
 Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
 Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
 Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
 Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)

LTE FDD/TDD operating bands:

Band 1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
 Band 2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
 Band 3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
 Band 4: 1710 to 1755 MHz (UL), 2110 to 2155 MHz (DL)
 Band 5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
 Band 7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
 Band 8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
 Band 12: 699 to 716 MHz (UL), 729 to 746 MHz (DL)
 Band 13: 777 to 787 MHz (UL), 746 to 756 MHz (DL)
 Band 14: 788 to 798 MHz (UL), 758 to 768 MHz (DL)
 Band 17: 704 to 716 MHz (UL), 734 to 746 MHz (DL)
 Band 18: 815 to 830 MHz (UL), 860 to 875 MHz (DL)
 Band 19: 830 to 845 MHz (UL), 875 to 890 MHz (DL)
 Band 20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
 Band 25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
 Band 26: 814 to 849 MHz (UL), 859 to 894 MHz (DL)
 Band 28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
 Band 29: 717 to 728 MHz (DL)
 Band 30: 2305 to 2315 MHz (UL) 2350 to 2360 MHz (DL)
 Band 32: 1452 to 1496 MHz (DL)
 Band 34: 2010 to 2025 MHz (UL/DL)
 Band 38: 2570 to 2620 MHz (UL/DL)
 Band 39: 1880 to 1920 MHz (UL/DL)
 Band 40: 2300 to 2400 MHz (UL/DL)
 Band 41: 2496 to 2690 MHz (UL/DL)
 Band 42: 3400 to 3600 MHz (UL/DL)
 Band 43: 3400 to 3800 MHz (UL/DL)
 Band 46: 5150 to 5925 MHz (DL)
 Band 48: 3550 to 3700 MHz (UL/DL)
 Band 66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
 Band 71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)

5G NR Sub 6GHz

n1: 1920 to 1980 MHz (UL), 2110 to 2170 MHz (DL)
 n2: 1850 to 1910 MHz (UL), 1930 to 1990 MHz (DL)
 n3: 1710 to 1785 MHz (UL), 1805 to 1880 MHz (DL)
 n5: 824 to 849 MHz (UL), 869 to 894 MHz (DL)
 n7: 2500 to 2570 MHz (UL), 2620 to 2690 MHz (DL)
 n8: 880 to 915 MHz (UL), 925 to 960 MHz (DL)
 n20: 832 to 862 MHz (UL), 791 to 821 MHz (DL)
 n25: 1850 to 1915 MHz (UL), 1930 to 1995 MHz (DL)
 n28: 703 to 748 MHz (UL), 758 to 803 MHz (DL)
 n38: 2570 to 2620 MHz (UL/DL)
 n40: 2300 to 2400 MHz (UL/DL)
 n41: 2496 to 2690 MHz (UL/DL)
 n48: 3550 to 3700 MHz (UL/DL)
 n66: 1710 to 1800 MHz (UL), 2110 to 2200 MHz (DL)
 n71: 663 to 698 MHz (UL), 617 to 652 MHz (DL)
 n77: 3300 to 4200 MHz (UL/DL)
 n78: 3300 to 3800 MHz (UL/DL)
 n79: 4400 to 5000 MHz (UL/DL)

Technical Specifications

Wireless protocol standards	5G NR Air Interface 3GPP Rel15 5G NR sub-6 LTE Rel14 20 layers and 2 Gbps downlink (DL) throughput – 4 × 4 MIMO across 5x CA 200 Mbps/uplink (UL) throughput – 40 MHz ULCA and 256 QAM WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
GPS	Standalone, A-GPS (MS-A, MS-B)
GPS bands	GPS: L1 (1575.42MHz) GLONASS: L1 (1602MHz) BeidouB1(1561.098MHz) Galileo E1 (1575.42) QZSS(1575.42 MHz)
Maximum data rates	SA 5G/NR sub-6 Peak: DL4.67Gbps/ UL 1.25Gbps 5G NSA sub 6G : DL: 3.8 Gbps/UL 700Mbps LTE: ue-CategoryDL 19, (DL : 1.6 Gbps) ue-CategoryUL 13 , (UL: 150Mbps)
Maximum output power	DC-HSPA+: 42 Mbps (Download), 11.5 Mbps (Upload) LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm NR: 23 dBm in all band except n41, n77, n78 and n79 LTE n41, n77, n78 and n79 HPUE = 26dBm HSPA+: 23.5 dBm
Maximum power consumption	5G Sub 6 : 2500 mA LTE: 1,300 mA (peak); 1100 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
Form Factor	M.2, 3042-S3 Key B
Weight	8 g
Dimensions (Length x Width x Thickness)	52 mm × 30 mm × 2.6 mm

1. Intel 5G module is optional and must be configured at the factory. Module designed for 5G NR NSA (non-standalone) networks as carriers deploy Evolved-Universal Terrestrial Radio Access New Radio Dual Connectivity (ENDC) with both 100Mhz of 5G NR and LTE channel bandwidth, using 256QAM 4x4 as defined by 3GPP. Module requires activation and separately purchased service contract. Check with service provider for coverage and availability in your area. Data connection, upload and download speeds will vary due to network, location, environment, network conditions, and other factors. Backwards compatible to 4G LTE and 3G HSPA technologies. 5G module planned to be available in select platforms and select countries, where carrier supported.

Technical Specifications

Intel® XMM™ 7560 R+ LTE-Advanced Pro¹	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4), 850 (Band 5), 900 (Band 8) MHz
	Wireless protocol standards	3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
	GPS	Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum data rates	LTE: 978 Mbps (Download), 150 Mbps (Upload) DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload) HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output power	LTE: 23 dBm in all band except B41 LTE B41 HPUE = 26dBm HSPA+: 23.5 dBm
	Maximum power consumption	LTE: 1,200 mA (peak); 900 mA (average) HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g
	Dimensions (Length x Width x Thickness)	42 x 30 x 2.3 mm
	eSIM	Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Technical Specifications

Near Field Communications Controller (optional)	Dimensions (L x W x H)	Module 25 mm by 10 mm by 2.0 mm
	Chipset	NPC100
	System interface	I2C
	NFC RF standards	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092 ECMA-340 NFCIP-1 Target and Initiator ECMA-320 NFCIP-2
	NFC Forum Support	Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2
	Reader (PCD-VCD) Mode (1)	ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire FeliCa Jewel and Topaz cards
	Card Emulation (PICC-VICC) Mode (1)	ISO/IEC 14443 A ISO/IEC 14443 B and B' MIFARE FeliCa
	Frequency	13.56 MHz
	NFC Modes Supported	Reader/Writer, Peer-to-Peer
	Raw RF Data Rates	106, 212, 424, 848 kbps
	Operating temperature	0°C to 70°C
	Storage temperature	-20°C to 125°C
	Humidity	10-90% operating 5-95% non-operating
	Supply Operating voltage	4.35 to 5.25 Volts
	I/O Voltage	1.8V or 3.3V
	Power Consumption (Booster enable, VBAT= 3.3V, VCC_BOOST = 5V)	
	Mode	Power Consumption, Typical
	Polling	7.3 mA
	Detected Test Tag Type 1	Total 283.8 mA Net Module 236.8 mA
	Detected Test Tag Type 2	Total 288.8 mA Net Module 241.8 mA
	Detected Test Tag Type 3	Total 287.7 mA Net Module 240.7 mA
	Detected Test Tag Type 4	Total 282.3 mA Net Module 235.3 mA
	Antenna	Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is external to module.

Technical Specifications

POWER

1. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors

AC Adapter 45 Watt nPFC Standard USB type C Straight 1.8m	Dimensions (H x W x D)	94.0mm x 40.0mm x 26.5mm	
	Weight	192.5g +/-10%	
Output	Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V : 81.5% 9V : 86.7% 12V : 87.41% 15V : 87.8%
	Connector	Input frequency range	47 ~ 63Hz
		Input AC current	Max. 1.4 A at 90 Vac
		Output power	5V/15W 9V/27W 12V/36W 15V/45W
		DC output	5V/9V/12V/15V
	Environmental Design	Hold-up time	5ms at 115 Vac input
		Output current limit	<5.0A
		Operating temperature	32°F to 95°F (0° to 35°C)
		Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)
		Altitude	0 to 16,400 ft (0 to 5000m)
EMI and Safety Certifications	Connector	Humidity	20% to 95%
		Storage Humidity	10% to 95%
		Eg: *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.	

AC Adapter 65 Watt nPFC Slim USB type C Straight 1.8m	Dimensions (H x W x D)	88x53.5x21mm	
	Weight	unit: 220g +/- 10g	
Input	Input Efficiency	81.5% min at 115 Vac/ 230Vac @ 5V/3A 86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A 89% min at 115 Vac/ 230Vac @ 20V/3.25A	
		Input frequency range	
		47 ~ 63 Hz	
		Input AC current	
		1.6 A at 90 VAC and maximum load	

Technical Specifications

Output	Output power	65W
	DC output	5V/9V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<8.0A
Connector	C6	
Environmental Design	Operating temperature	32°F to 95°F (0° to 35°C)
	Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	5% to 95%
	Storage Humidity	5% to 95%
EMI and Safety Certifications	Eg: *CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.	

AC Adapter 65 Watt nPFC Standard USB type C Straight 1.8m	Dimensions (H x W x D)	90.0mm x 51.0mm x 28.5mm
	Weight	250g +/-10%
Input	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5% 9V: 86.7% 12V: 88% 15V: 88% 20V: 89%
	Input frequency range	47 ~ 63Hz
Output	Input AC current	Max. 1.6 A at 90 Vac
	Output power	5V/15W 9V/27W 12V/60W 15V/60W 20V/65W
	DC output	5V/9V/12V/15V/20V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<8.0A
	Connector	C6
Environmental Design	Operating temperature	32°F to 95°F (0° to 35°C)
	Non-operating (storage) temperature	-4°F to 185°F (-20° to 85°C)



Technical Specifications

EMI and Safety Certifications	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	Eg:	
	*CE Mark - full compliance with LVD and EMC directives * Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1 , Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.	

HP 3-cell Long Life Li-Ion (38Wh)¹	Dimensions (H x W x D)	251.8 x 66.1 x 6.82mm (9.91 x 2.6 x 0.27 inch)
	Weight	0.184kg +/- 10g(0.406lb)
	Cells/Type	3cell Lithium-Ion Polymer cell / 564975
	Energy	Voltage 11.58V
		Amp-hour capacity 3.283Ah
		Watt-hour capacity¹ 38Wh
		Temperature
	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging) 14° to 140° F (-10° to 60° C)
	Fuel Gauge LED	NA
	Warranty	Follow product spec
	Optional Travel Battery Available	No

HP 3-cell Long Life Li-Ion (51 Wh)¹	Dimensions (H x W x D)	251.8 x 70.3 x 6.82mm (9.91 x 2.77 x 0.27 inch)
	Weight	0.229kg +/- 10g (0.505 lb)
	Cells/Type	3cell Lithium-Ion Polymer cell / 566075
	Energy	Voltage 11.58V
		Amp-hour capacity 4.431Ah
		Watt-hour capacity¹ 51.3Wh
		Temperature
	Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging) 14° to 140° F (-10° to 60° C)
	Fuel Gauge LED	NA
	Warranty	Follow product spec
	Optional Travel Battery Available	No

Technical Specifications**AUDIO**

HD Stereo Codec	Realtek ALC3315
Audio I/O Ports	Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	Cirrus Logic High-Efficiency Boosted Class D Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio. Following MSFT Behaviour
Sampling	DAC: 44.1k/48kHz ADC: 48kHz
Wavetable Syntheses	
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
# of Channels on Line-Out	
Internal Speaker	Yes

FINGERPRINT READER

Sensor vendor	Synaptics FS7604
Sensor type	Capacitive
DPI resolution	363DPI
Scan area	7.4x6mm sensor area
False Rejection Rate	<1%
False Acceptance Rate	1:50K FAR
Mobile Voltage Operation	3.0V to 3.6V
Operating Temperature	0~60°C
Current Consumption	100mA Max
Image	
Low Latency Wait For Finger	260 uA
Capture Rate	<30msec per image
ESD Resistance	IEC 61000-4-2 4B (+/-15KV)
Detection Matrix	363 dpi / 7.4x6mm sensor area

Technical Specifications

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: <ul style="list-style-type: none"> • IT ECO declaration • US ENERGY STAR® • US Federal Energy Management Program (FEMP) • EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country. • TCO Certified • China Energy Conservation Program (CECP) • China State Environmental Protection Administration (SEPA) • Taiwan Green Mark • Korea Eco-label • Japan PC Green label* 		
Sustainable Impact Specifications	<ul style="list-style-type: none"> • Ocean-bound plastic in Speaker • 60% post-consumer recycled plastic • Low halogen • Outside Box and corrugated cushions are 100% sustainably sourced and recyclable • Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable • Bulk packaging available 		
System Configuration	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".		
Energy Consumption (in accordance with US ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	5.88 W	6.17 W	5.92 W
Normal Operation (Long idle)	1.66 W	1.85 W	1.76 W
Sleep	1.66 W	1.85 W	1.76 W
Off	0.46 W	0.48 W	0.41 W
	NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.		
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	20.1 BTU/hr	21.1 BTU/hr	20.2 BTU/hr
Normal Operation (Long idle)	5.7 BTU/hr	6.3 BTU/hr	6 BTU/hr
Sleep	5.7 BTU/hr	6.3 BTU/hr	6 BTU/hr
Off	1.6 BTU/hr	1.6 BTU/hr	1.4 BTU/hr
	*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.		
Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)	

Technical Specifications

Typically Configured – Idle	2.9	21.6
Fixed Disk – Random writes	3.6	28.5
Optical Drive – Sequential reads	4.1	33.2
Longevity and Upgrading	This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the	
	Spare parts are available throughout the warranty period and or for up to “5” years after the end of production.	
Additional Information	<ul style="list-style-type: none"> This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. This product is 95.4% recycle-able when properly disposed of at end of life. 	
Packaging Materials	External:	269 g
	PAPER/Corrugated	
	PAPER/Paper	3 g
	PAPER/Molded Pulp	108 g
	Internal:	13 g
	PLASTIC/Polyethylene low density - LDPE	
	The plastic packaging material contains at least 0.0% recycled content.	
	The corrugated paper packaging materials contains at least 59.1% recycled content.	
RoHS Compliance	<p>HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.</p> <p>We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.</p> <p>We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.</p> <p>To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.</p>	
Material Usage	<p>This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):</p> <ul style="list-style-type: none"> Asbestos Certain Azo Colorants Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium Chlorinated Hydrocarbons Chlorinated Paraffins 	

Technical Specifications

	<ul style="list-style-type: none"> • Bis(2-Ethylhexyl) phthalate (DEHP) • Benzyl butyl phthalate (BBP) • Dibutyl phthalate (DBP) • Diisobutyl phthalate (DIBP) • Formaldehyde • Halogenated Diphenyl Methanes • Lead carbonates and sulfates • Lead and Lead compounds • Mercuric Oxide Batteries • Nickel – finishes must not be used on the external surface designed to be frequently handled or carried by the user. • Ozone Depleting Substances • Polybrominated Biphenyls (PBBs) • Polybrominated Biphenyl Ethers (PBBEs) • Polybrominated Biphenyl Oxides (PBBOs) • Polychlorinated Biphenyl (PCB) • Polychlorinated Terphenyls (PCT) • Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications. • Radioactive Substances • Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBT0)
Packaging Usage	<p>HP follows these guidelines to decrease the environmental impact of product packaging:</p> <ul style="list-style-type: none"> • Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. • Eliminate the use of ozone-depleting substances (ODS) in packaging materials. • Design packaging materials for ease of disassembly. • Maximize the use of post-consumer recycled content materials in packaging materials. • Use readily recyclable packaging materials such as paper and corrugated materials. • Reduce size and weight of packages to improve transportation fuel efficiency. • Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	<p>HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.</p> <p>The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.</p>

Technical Specifications

HP, Inc. Corporate Environmental Information	<p>For more information about HP's commitment to the environment:</p> <p>Global Citizenship Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html</p> <p>Eco-label certifications http://www8.hp.com/us/en/hp-information/environment/ecolabels.html</p> <p>ISO 14001 certificates: http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf</p>
footnotes	<ul style="list-style-type: none">• Percentage of ocean-bound plastic contained in each component varies by product• Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.• External power supplies, WWAN modules, power cords, cables and peripherals excluded.• 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.• Fiber cushions made from 100% recycled wood fiber and organic materials.

COUNTRY OF ORIGIN

China

Options and Accessories (Sold separately and availability may vary by country)

DOCKING (Sold Separately)

Docking station model #1	HP Thunderbolt Dock G2
Total number of supported displays (incl.the notebook display)	4
Max.resolutions supported	Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported Single 8K@ 30Hz (multiple tiles) for Thunderbolt hosts Non-TBT hosts DP 1.4 in high res mode (1) 8K video single cable@30Hz [10] 2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode
Dock Connectors	Thunderbolt Hosts: Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host. Max resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in High Resolution mode @30Hz Non-Thunderbolt hosts: The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is (1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port Non-Thunderbolt hosts support (3) displays with a max resolution of: (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi-function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.
Docking station model #2	HP USB-C Dock G5
Total number of supported displays (incl.the notebook display)	3
Max.resolutions supported	Dual 5K@ 30Hz + (1) 4K UHD (multi-function mode) [10] 1xHDMI, 2xDP
Dock Connectors	Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode. Three maximum displays supported are two 5K@ 30 Hz on DP ports plus one 4K UHD@ 30 Hz on HDMI in multi-function mode The highest resolution for a non-Thunderbolt host in Multi-function mode is a single 5K dual cable (using both DP ports) + (1) 4K on HDMI port.
Technical limitations	
Docking station model #3	HP USB-C/A Universal Dock G2
Total number of supported displays (incl.the notebook display)	3
Max.resolutions supported	Triple 4K UHD@ 60Hz [10] 1xHDMI, 2xDP
Dock Connectors	The best resolution for dual or triple displays is 4K UHD@ 60Hz. For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host
Technical limitations	

Options and Accessories (Sold separately and availability may vary by country)

Type	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA,2E6V0AA
	HP Renew Business 14.1 Laptop Bag	3E5F9AA
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
Docking	HP Thunderbolt 120W G2 Dock (Hook)	2UK37AA
	HP Thunderbolt 120W G2 Dock w/Audio (HOOK+MIXMASTER)	3YE87AA
	HP Thunderbolt 230W G2 Dock w/Combo Cable (Hook)	3TR87AA
	HP USB-C 120W G5 Dock (AdicoraA)	5TW10AA
	HP USB-C/A 120W G2 Universal Dock (Adicora-D)	5TW13AA
Hub	HP USB-C Mini Dock	1PM64AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB to Gigabit RJ45 Adapter	N7P47AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to RJ45 Adapter	V7W66AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA
	HP USB-C to RJ45 Adapter G2	4Z527AA
	HP USB 3.0 to Gigabit RJ45 Adapter G2	4Z7Z7AA
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA

Options and Accessories (Sold separately and availability may vary by country)

	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1D0K8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
	HP 65W USB-C Travel Slim Kermit AC Power Adapter	3PN48AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA

Change Log

Date of change:	Version History:		Description of change:
September 7, 2022	V1 to V2	Removed	Tile App
October 19, 2022	V2 to V3	Updated	Bluetooth version
December 7, 2022	V3 to V4	Updated	Windows OS
	V4 to V5		

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